

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5132103

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JIA JIAN DU	09/07/2018
RECEIVING PARTY DATA	
Name:	HAYCO MANUFACTURING LIMITED
Street Address:	3002 CITICORP CENTRE, 18 WHITFIELD ROAD
City:	CAUSEWAY
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29662836
CORRESPONDENCE DATA	
Fax Number:	(518)452-5579
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	5184525600
Email:	zes@hrfmlaw.com
Correspondent Name:	NICHOLAS MESITI, ESQ.
Address Line 1:	5 COLUMBIA CIRCLE
Address Line 4:	ALBANY, NEW YORK 12203
ATTORNEY DOCKET NUMBER:	3653.058
NAME OF SUBMITTER:	NICHOLAS MESITI
SIGNATURE:	/NICHOLAS MESITI/
DATE SIGNED:	09/10/2018
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	
source=3653058 Declaration and Assignment Final (H1282666xD16FB)#page1.tif	
source=3653058 Declaration and Assignment Final (H1282666xD16FB)#page2.tif	
source=3653058 Declaration and Assignment Final (H1282666xD16FB)#page3.tif	

Attorney Docket No.: 3653.058

ASSIGNMENT AND DECLARATION

WHEREAS, I,

Jia Jian DU, a Chinese citizen, of The 2nd Industrial Estate, Yan Chuan, Song Gang, Bao An, Shenzhen City, Guangdong Province, China;

(hereinafter INVENTOR) has invented certain new and useful improvements in

COMBINATION BRUSHES AND PART THEREOF

which is the subject of United States Application Serial Number 29/662,836 filed September 10, 2018, and

WHEREAS, **HAYCO MANUFACTURING LIMITED**, a company organized and existing under the laws of Hong Kong, of 3002 Citicorp Centre, 18 Whitfield Road, Causeway, Hong Kong, is desirous of obtaining the entire right, title and interest in, to and under said improvements and said application; and

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, I, the above identified INVENTOR, hereby assign, transfer and set over to **HAYCO MANUFACTURING LIMITED**, its successors, legal representatives and assigns, the entire right title and interest in, to and under said improvements, the above-identified application - including the right to claim priority to said application - all divisions, renewals and continuations thereof, and all Letters Patent which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to **HAYCO MANUFACTURING LIMITED**, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

Attorney Docket No.: 3653.058

AND I HEREBY further covenant and agree that I will communicate to **HAYCO MANUFACTURING LIMITED**, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid **HAYCO MANUFACTURING LIMITED**, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries;

AND I HEREBY grant **Heslin Rothenberg Farley & Mesiti P.C.** the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document;

AND I HEREBY grant **Melvin S. Li** the power to execute Assignments or other documentations needed for use in filing applications claiming priority from or otherwise corresponding to the subject United States Application, which may be necessary or desirable in order to comply with the rules of the Patent Offices in which those applications are filed;

AND I HEREBY, as the above named inventor, declare that the above-identified application was made or authorized to be made by myself;

AND I HEREBY, as the above named inventor, declare that I believe that I am the original inventor of a claimed invention in the above-identified application;

AND I HEREBY state that I have reviewed and understand the contents of the above-identified specification, including the claims;

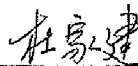
AND I HEREBY acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

AND I HEREBY declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that any willful false statements and the like so made in this declaration are punishable by fine or imprisonment of not more than five (5) years, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Attorney Docket No.: 3653.058

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this ____ day of

- 7 SEP 2018, 2018.

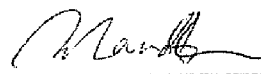


Jia Jian DU



Witness

Printed Name: BEATRICE LOK KIT CHENG,
Residence Address: 3002 Citizens Centre
18 Whitfield Road, Hong Kong.



Witness

Printed Name: WU SZE LAI MANDY
Residence Address: 3002 Citizens Centre
18 Whitfield Road, Hong Kong

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this ____ day of

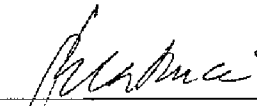
- 7 SEP 2018, 2018.



For and on behalf of
HAYCO MANUFACTURING LIMITED



Witness WU SZE LAI MANDY



Witness LOK KIT CHENG, BEATRICE